

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Field device integration (FDI) –
Part 100: Profiles – Generic protocols**

**Intégration des appareils de terrain (FDI) –
Partie 100: Profils – Protocoles génériques**



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FIELD DEVICE INTEGRATION (FDI) –

Part 100: Profiles – Generic protocols

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FCG TS62769-100 Edition 1.1, *Field Device Integration Part 100: Profiles – Generic Protocols*, a specification of the FieldComm Group, PROFIBUS Nutzerorganisation e. V., OPC Foundation and FDT Group, serves as a basis for the elaboration of this standard.

The text of this International Standard is based on the following documents:

FDIS	Report on voting
65E/739/FDIS	65E/743/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

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